

ALPHA® EF-6850HF

Halogen-Free, Low-Solids, Alcohol-Based, No-Clean Wave Soldering Flux

DESCRIPTION

ALPHA EF-6850HF is a halogen-free, low-solids, alcohol-based, no-clean flux for lead-free wave soldering. It is formulated for both standard and thicker, high-density PCBs used in lead-free applications. It is designed for low bridging to provide superior performance in pin testing, hole-fill and solderballing. Additionally, it provides good cosmetics with a uniform, tack-free residue.

READ ENTIRE TECHNICAL DATA SHEET BEFORE USING THIS PRODUCT

FEATURES & BENEFITS

Features:

- Halogen-free
- Unique activator / package
- Compliant to GR-78-CORE (Telcordia/Bellcore)
- Low surface tension
- Thermally stable
- Tack-free residue

Benefits:

- Environmentally friendly. Complies with halogen free industry standards
- Produces highly reliable assemblies with excellent cosmetics and pin testability
- High through hole penetration rate and uniform SMT pad coverage
- Excellent soldering in both single and dual wave processing using SAC305 or other low silver alloys
- Pin testable, uniform, transparent, tack free residue





APPLICATION GUIDELINES

Preparation: In order to maintain consistent soldering performance and electrical reliability, it is important to begin the process with circuit boards and components that meet established requirements for solderability and ionic cleanliness. It is suggested that assemblers establish specifications on these items with their suppliers and that suppliers provide Certificates of Analysis with shipments and/or assemblers perform incoming inspection. A common specification for the ionic cleanliness of incoming boards and components is $10 \, \mu g/in2 \, maximum$, as measured by an Omegameter with heated solution.

Care should be taken in handling the circuit boards throughout the process. Boards should always be held at the edges. The use of clean, lint-free gloves is also recommended.

Conveyors, fingers and pallets should be cleaned regularly to reduce the build-up of flux residues. ALPHA AutoClean 40 cleaner is recommended for this process.

Flux Application: ALPHA EF-6850HF can be applied by spray, foam or wave application. A uniform coating of flux is essential to successful soldering. When applying flux, it is important to run a series of tests to ensure that the flux is being applied uniformly, that it is penetrating from top to bottom of the board on all holes to be soldered and to make sure that excessive amounts of flux are not being applied.

There are various methods for conducting these tests. Consult with your local Alpha Customer Technical Service Representative for more information.

Operating Parameter	SAC 305 or Low Ag SAC alloys
Amount of Elux Applied	Single : 1,200 to 1,600 μg/in² solids
Amount of Flux Applied	Dual :1,400 to 2,000 μg/in² solids
Top Side Preheat Temperature	90 to 120 °C
Bottom side Preheat Temperature	110 to 140 °C
Recommended Preheat Profile	Straight ramp to desired top-side temperature
Maximum Ramp Rate of Topside Temperature (to avoid component damage)	2 °C/second (35 °F/second) maximum
Contact Time in the Solder (includes Chip Wave and Primary Wave)	3 to 6 seconds
Solder Pot Temperature	255 to 265 °C

These are general guidelines which have proven to yield excellent results; however, depending upon your equipment, components, and circuit boards, your optimal settings may be different. In order to optimize your process, it is recommended to perform a design experiment, optimizing the most important variables (amount of flux applied, conveyor speed, topside preheat temperature, solder pot temperature and board orientation).







Flux Solids Control: If rotary drum spray fluxing, the flux solids will need to be controlled via thinner addition. For measuring the solids content, Alpha's Flux Solids Control Kit #3, a digital titrator, is suggested. Request Alpha's Reference Bulletin for details on the kit and titration procedure. When operating a rotary drum fluxer continuously, the acid number should be checked every eight hours. Over time, debris and contaminants will accumulate in recirculating type flux applicators. For consistent soldering performance, dispose of spent flux every 40 hours of operation. After emptying the flux, the reservoir should be thoroughly cleaned with IPA.

Residue Removal: ALPHA EF-6850HF is a no-clean flux and the residues are designed to be left on the board. If desired, flux residues can be removed with ALPHA 2110 saponifier cleaner and with other commercially available solvent cleaners and saponifier cleaners.

HALOGEN STATUS

Standard	Requirement	Test Method	Status
IEC 61249-2-21	Post soldering residues contain <900ppm each or total of <1500ppm Br or CI from flame retardant source	TM EN 14582 Solids extraction	PASS
JEDEC - A Guideline for Defining "Low Halogen" Electronic products	Post soldering residues contain <1000ppm Br or Cl from flame retardant source	per IPC TM 2.3.34	PASS

TECHNICAL DATA

Physical Properties	Typical Values	Parameters/Test Method	Typical Values	
A	Clear,	pH, 5% v/v aqueous	2.8	
Appearance	Light Amber	solution		
Solids Content, wt/wt	4.0%	Recommended Thinner	ALPHA 425	
Specific Gravity @ 25 °C (77 °F)	0.793	Shelf Life	12 months	
Acid Number (mg KOH/g)	21.47	IPC J-STD-004	ROL0	
Flash Point (T.C.C.)	17 °C	Designation		





CORROSION & ELECTRICAL TESTING - SAC305 ALLOY

Corrosion Test

Test		Requirement for ROL0	Results
	Silver Chromate Paper	No detection of halide	PASS
	IPC-TM 650 Test Method 2.3.33	No detection of fialide	
	Copper Mirror Test	No complete removal of conner	PASS
IPC	PC IPC-TM 650 Test Method 2.3.32	No complete removal of copper	
	Copper Corrosion Test	No evidence of corrosion	PASS
	IPC-TM650 Test Method 2.6.15	N/A	
JIS	Copper Corrosion Test	No evidence of corrosion	PASS
	JIS Z3197:1999 Test Method 8.4.1	No evidence of corrosion	

IPC J-STD-004B Surface Insulation Resistance

Test	Requirements (<1.0 x 10 ⁸ allowed during initial 24 hrs.)	Results (min. of all measurements recorded)		
		< 24 Hrs	24 to 168 Hrs	Visual
"Comb-Down" Un- cleaned	> 1.0 x 10 ⁸ Ω	6.8 x 10 ¹⁰ Ω	6.2 x 10 ¹⁰ Ω	PASS
"Comb-Up" Un-cleaned	> 1.0 x 10 ⁸ Ω	1.4 x 10 ¹⁰ Ω	2.7 x 10 ¹⁰ Ω	PASS
Control Boards	> 1.0 x 10 ⁹ Ω	1.8 x 10 ¹¹ Ω	1.8 x 10 ¹¹ Ω	NA

IPC Test Condition (per J-STD-004B TM2.6.3.7): IPC B-24 coupons, 12V, 40 °C, 90% RH, measurements recorded @ 20min intervals

JIS Standard Surface Insulation Resistance

Test	Conditions	Requirements	Controls	Results
Initial	Ambient	> 1.0 x 10 ¹¹ Ω	$9.7 \times 10^{11} \Omega$	9.8 x 10 ¹¹ Ω
After 7 days	40 °C / 90% RH	> 1.0 x 10 ¹⁰ Ω	$1.0 \times 10^{12} \Omega$	7.5 x 10 ¹¹ Ω
Recovered	25 °C/75% RH, 7 days	> 1.0 x 10 ¹¹ Ω	$1.0 \times 10^{12} \Omega$	1.0 x 10 ¹² Ω

All Measurements @ 100V, JIS Boards

(0.32mm lines, 0.32 mm spacing, same as IPC B25 Boards).



Bellcore Surface Insulation Resistance

Test	Conditions	Requirements ¹	Results ¹
"Comb-Down" Un-cleaned	35 °C/85% RH, 4 days	> 1.0 x 10 ¹¹ Ω	3.6 x 10 ¹¹ Ω
"Comb-Up" Un-cleaned	35 °C/85% RH, 4 days	> 1.0 x 10 ¹¹ Ω	> 1.0 x 10 ¹² Ω
Control Boards	35 °C/85% RH, 4 days	> 2.0 x 10 ¹¹ Ω	> 1.0 x 10 ¹² Ω

Bellcore Test Condition (per GR 78-CORE, Issue 1: 48 Volts, measurement @ 100V/25 mil lines/50 mil spacing.

Bellcore Electromigration

Test	SIR (Initial)¹	SIR (Final) ¹	Requirement	Result	Visual Result
"Comb-Up"	1.0 x 10 ¹¹ Ω	3.5 x 10 ¹¹ Ω	SIR (Initial)/SIR (Final) <10	0.29	PASS
Un-cleaned	1.0 X 10 22	3.5 X 10 12		0.29	FAGG
"Comb-Down"	2.1 x 10 ¹⁰ Ω	6.5 x 10 ¹⁰ Ω	SIR (Initial)/SIR (Final) <10	0.32	PASS
Un-cleaned	2.1 X 10 ° 12	0.5 X 10 · 12		0.32	FASS
Control	1.0 x 10 ¹¹ Ω	5.9 x 10 ¹¹ Ω	Not applicable	0.17	PASS

Bellcore Test Condition (per GR 78-CORE, Issue 1): 65 °C/85% RH/500 Hours/10V, measurement @ 100V/IPC

B-25B Pattern (12.5 mil lines, 12.5 mil spacing).

RECYCLING SERVICES

We provide safe and efficient recycling services to help companies meet their environmental and legislative requirements and at the same time, maximize the value of their waste streams.

Our service collects solder dross, solder scrap, and various forms of solder paste waste. Please contact your local sales representative for recycling capabilities in your area or <u>link here</u>.







SAFETY & WARNING

It is recommended that the company/operator read and review the Safety Data Sheets for the appropriate health and safety warnings before use. **Safety Data Sheets are available at MacdermidAlpha.com/assembly-solutions/knowledge-base.**

CONTACT INFORMATION

To confirm this document is the most recent version, please contact Assembly@MacDermidAlpha.com

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Also read carefully warning and safety information on the Safety Data Sheet. This data sheet contains technical information required for safe and economical operation of this product. READ IT THOROUGHLY PRIOR TO PRODUCT USE . Emergency safety directory assistance: US 1 202 464 2554, Europe + 44 1235 239 670, Asia + 65 3158 1074, Brazil 0800 707 7022 and 0800 172 020, Mexico 01800 002 1400 and (55) 5559 1588

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